# Observation of grain-boundary on bicrystal

#### Tetsuro Maki, Yoshihiro Nakatani, Xiangyan Kong Akinori Yutani and Hideo Itozaki

Graduate School of Engineering Science, Osaka University

#### Masayuki Abe and Toshimasa Matsuoka Graduate School of Engineering, Osaka University

GCOE CEDI Osaka Univ. EDIS 2008







1. The aim of our IDER unit

### 2. The members of the unit and each role

## **3. Recent activity of our unit** FE-SEM and AFM observations of the grain-boundaries on bicrystal

# 4. Conclusions





The final aim of our Innovation-oriented Dynamic Education and Research (IDER) unit is

to improve the grain-boundary junction properties and to develop the high-quality high-T<sub>c</sub> Josephson junction devices

such as superconducting quantum interference devices (SQUIDs) or THz detectors.





The members of the unit and each role are

Dr. T. Maki: a leader of the unit
Mr. Y. Nakatani: fabrication of high-T<sub>C</sub> superconducting thin films and the devices
Prof. M. Abe: observation by an atomic force microscopy (AFM)
Prof. T. Matsuoka: design of the device systems

Prof. H. Itozaki: an adviser of the unit

The research of the unit was carried out together with

Dr. X. Y. Kong: design and fabrication of the SQUIDs
Mr. A. Yutani: fabrication of high-T<sub>C</sub> superconducting thin films and the devices



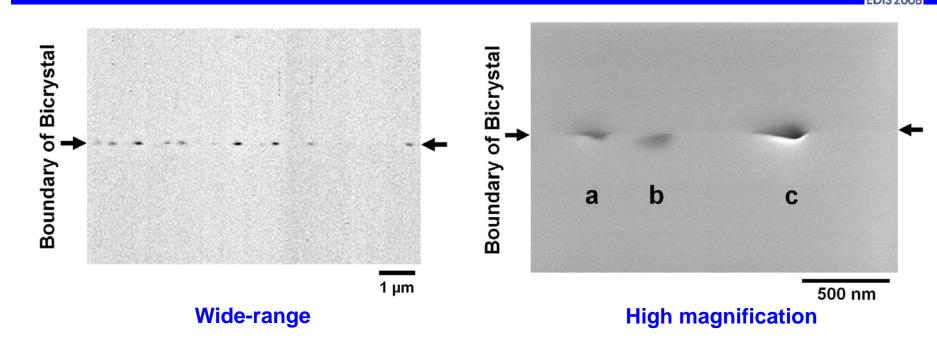


SrTiO<sub>3</sub> (STO) bicrystal substrates are useful for fabrication of grain-boundary Josephson junctions by growing  $YBa_2Cu_3O_{7-x}$  (YBCO) thin films on the substrates.

Since grain boundary surface of the bicrystal substrates influence the properties of the YBCO thin-film grain-boundary Josephson junctions grown on the substrates,

It is important to evaluate the surface of the bicrystal boundary of the substrates.

A field-emission scanning electron microscopy (FE-SEM) and an atomic force microscopy (AFM) observation of STO bicrystal substrates was used to observe the surface defects located along with the bicrystal boundary. Secondary electron images of the bicrystal boundary of a STO substrate with wide-range and high magnification



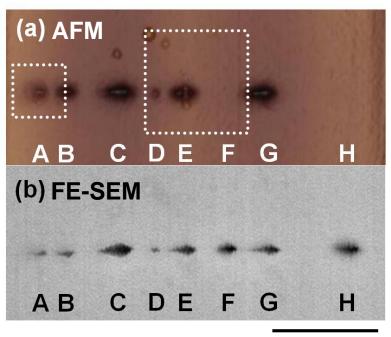
#### The high magnification image reveals the morphological difference between the defects b and c.

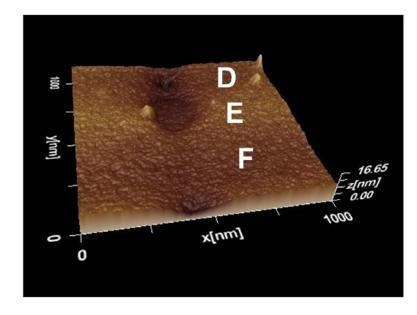
The defect **c** exhibits **a grooved shape**, however the defect **b** exhibits **the flat surface** and **the secondary electron emission was just suppressed**.

Y Osaka University

Comparison between AFM and FE-SEM observation of the defects at the bicrystal boundary of a STO substrate







1 µm

By comparing (a) AFM and (b) FE-SEM image,

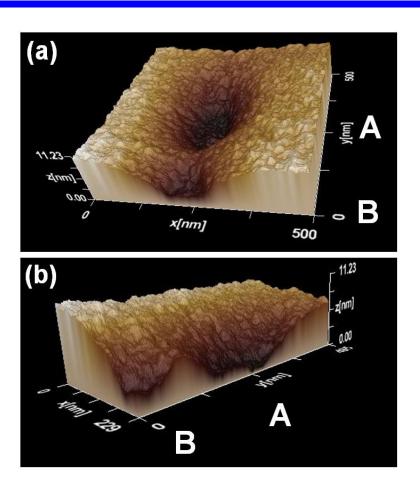
the defects observed in the secondary electron image mostly have a grooved shape. However, the defects of F and H have obviously no grooved shape, but the flat surface,

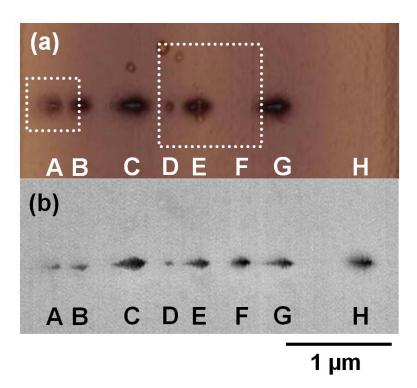
where the secondary electron emission was suppressed.

Osaka University

# AFM image of the enclosed area of the 500 nm square and the cross-sectional view



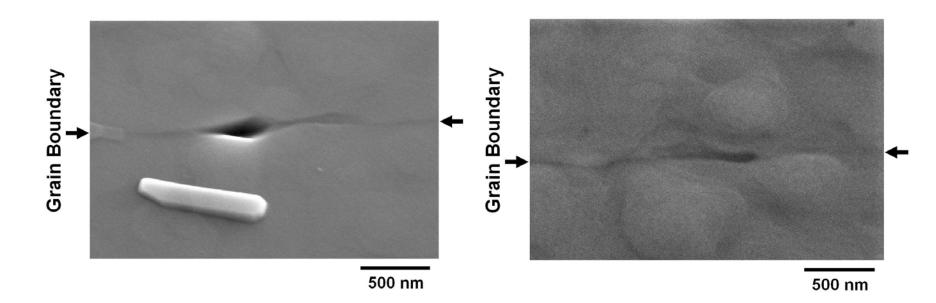




The depth of the defect A is estimated to around 10 nm.



Secondary electron images of the grain-boundary of an YBCO thin film grown on the STO bicrystal substrate



The defect of the groove is similar in shape to that of the substrate.

It was also found that an over-growth of the YBCO thin film occurred across the bicrystal boundary, resulting in the meandering shape of the grain boundary.





The characterization of the defects at bicrystal boundaries of the substrates and the defects at grain boundaries of the YBCO thin films grown on the bicrystal boundaries provided us the valuable information

to understand the mechanism of the formation of the defects at grain boundaries of the YBCO thin films grown on the bicrystal substrates.

This YBCO defect on the grain boundary might influence to depress **superconducting properties of Josephson junction**.

